

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

PCN# 20190813001.1 Qualification of additional Fab site (RFAB) and Assembly site (MLA and CDAT) options for select LBC7 devices Change Notification / Sample Request

The PCN is being re-sent as a replacement due to a possible system processing error. The TI systems indicate the PCN notification was issued successfully, however every effort is being made to ensure customers are notified of the change. The PCN date has been updated to reflect the most recent notification.

Date: August 28, 2019 **To:** PREMIER FARNELL PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (PCN_www_admin_team@list.ti.com). For sample requests or sample related questions, contact your local Field Sales Representative.

PCN Team SC Business Services

20190813001.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
BQ76925PW	null
TPS22920YZPR	null
TPS54821RHLR	null
TPS54821RHLT	null
TPS70612DBVT	null
TPS70612DRVT	null
TPS70615DBVT	null
TPS70618DRVT	null
TPS70628DBVT	null
TPS70628DRVT	null
TPS70633DBVT	null
TPS70915DRVT	null
TPS70918DBVT	null
TPS70925DBVT	null
TPS70925DRVT	null
TPS70927DBVT	null
TPS70928DBVT	null
TPS70930DBVR	null
TPS70930DBVT	null
TPS70933DBVR	null
TPS70933DBVT	null
TPS70936DBVT	null
TPS70939DBVT	null
TPS70950DBVR	null
TPS70950DBVT	null
TPS70960DBVT	null
TPS709B33DBVT	null
TPS709B50DBVT	null
TPS70615DRVT	null
TPS70625DRVT	null
TPS70630DRVT	null
TPS70633DRVT	null
TPS70916DBVT	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	2	20190813001.1 PCN Date: Aug 28, 2019				019				
Title: Qualification of additional Fab site (RFAB) and Assembly site (MLA and CDAT) options for select LBC7 devices										
Customer Contact: PCN Ma			<u>CN Manager</u>			Dept:			Quality Se	
Proposed 1 st Ship D	Date: Nov 28, 2019				Estima Availa	ated Sample			Date prov sample re	
Change Type:										
Assembly Site			Assembly Process Assembly Materials					erials		
Design			Electrical	_				Mechanical Specification		
Test Site			_		oing/Labeling				Test Process	
Wafer Bump Site	e		Wafer Bu				Щ	Wafer Bump Process		
								Waf	Wafer Fab Process	
			Part num							
			PC	N D	etails					
Texas Instruments is assembly (MLA and C	please	ites f			ces as listed b	oelow ir	n th	e prod		
						dditio				
Current Fab P Site	rocess	5	Wafer Diameter	,	Additional Fab Site	Pro	осе	SS	Wafer Diamete	
FFAB	LBC7		200 mm		RFAB	L	BC7	7	300 mm	1
Qual details are provided in the Qual Data Section. Reason for Change:										
Continuity of Supply		_								
Anticipated impact None	on Fo	rm, F	it, Function	1, QI	uality or Rel	iability	y (t	ositiv	ve / nega	tive):
Anticipated impact	on Ma	teria	al Declaration	on						
No Impact to the Material Declaration Material Declaration release. Up obtained from			data oon p om tl eetin	ations or Productions or Production re the TI Eco-Information grant regularization angle.	ivailabl lease th o webs	e fo he r <u>ite</u> .	ollowin evised There	g the prod d reports o e is no imp	luction an be act to the	
Changes to product	t ident	ifica				N:				
Fab Site Information:										
Chip Site		Chip Site Origin Code (20L)		า	Chip Site Country Code			de (21	(21L) Chip Site City	
FR-BIP-1		,	Code (20L)		Cimp Site C				Freising	
I V-DIL-I		<u> </u>	TID		Cimp Site C	DEU			Fi	<u> </u>
RFAB					Cimp Site C	DEU USA				<u> </u>
		on:	TID RFB			USA				eising
RFAB		on:	TID RFB Site Origin	As	sembly Coun	USA	de			reising nardson
RFAB Assembly Site Info		on:	TID RFB Site Origin (L)	As	sembly Coun	USA	de	Chur	Ricl	reising nardson
Assembly Site Info Assembly Site		o n: nbly 9	TID RFB Site Origin	As	sembly Coun (23L)	USA	de		Ricl	reising nardson City Taipei City

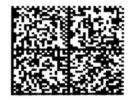
TI Chengdu CDA CHN Chengdu

Sample product shipping label (not actual product label)

TEXAS INSTRUMENTS

MADE IN: Malaysia 2DC: 2Q: MSL '2 /260C/1 YEAR SEAL DT MSL 1 /235C/UNLIM 03/29/04

OPT: ITEM: (L)T0:1750 LBL:



(1P) SN74LS07NSR (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483S12 (P) (P) (V) 0033317 (2P) REV: (21L) CCO:USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected:

Group 1: Adding RF	Group 1: Adding RFAB as an additional site				
BQ76925RGER	TPS70625DRVR	TPS70915DBVR	TPS70933DBVR		
BQ76925RGET	TPS70625DRVT	TPS70915DBVT	TPS70933DBVT		
SN1602044RHLR	TPS70628DBVR	TPS70915DRVR	TPS70936DBVR		
SN1602044RHLT	TPS70628DBVT	TPS70915DRVT	TPS70936DBVT		
SN1603068DBVR	TPS70628DRVR	TPS70916DBVR	TPS70938DBVR		
TPS54821RHLR	TPS70628DRVT	TPS70916DBVT	TPS70938DBVT		
TPS54821RHLT	TPS70630DBVR	TPS70918DBVR	TPS70939DBVR		
TPS70612DBVR	TPS70630DBVT	TPS70918DBVT	TPS70939DBVT		
TPS70612DBVT	TPS70630DRVR	TPS70919DBVR	TPS70950DBVR		
TPS70612DRVR	TPS70630DRVT	TPS70919DBVT	TPS70950DBVT		
TPS70612DRVT	TPS70633DBVR	TPS70925DBVR	TPS70960DBVR		
TPS70615DBVR	TPS70633DBVT	TPS70925DBVT	TPS70960DBVT		
TPS70615DBVT	TPS70633DRVR	TPS70925DRVR	TPS709A30DBVR		
TPS70615DRVR	TPS70633DRVT	TPS70925DRVT	TPS709A30DBVT		
TPS70615DRVT	TPS70912DBVR	TPS70927DBVR	TPS709A33DBVR		
TPS70618DBVR	TPS70912DBVT	TPS70927DBVT	TPS709A33DBVT		
TPS70618DBVT	TPS70912DRVR	TPS70928DBVR	TPS709B33DBVR		
TPS70618DRVR	TPS70912DRVT	TPS70928DBVT	TPS709B33DBVT		
TPS70618DRVT	TPS709135DBVR	TPS70930DBVR	TPS709B50DBVR		
TPS70625DBVR	TPS709135DBVT	TPS70930DBVT	TPS709B50DBVT		
TPS70625DBVT		·			

Group 2: Adding RFAB and MLA Assembly as additional sites				
BQ76925PW	BQ76925PWR			

Group 3: Adding RFAB and CDAT Assembly as additional sites				
TPS22920YZPR	TPS22920YZPRB	TPS22920YZPT		

Qualification Report

Approve Date 13-August-2019

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TP\$51217D\$C
ED	Electrical Characterization	Per Datasheet Parameters	Pass
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0
AC	Autoclave, 121C	96 Hours	3/231/0
HBM	ESD - HBM	2000 V	3/9/0
CDM	ESD - CDM	500 V	3/9/0
HTOL	Life Test, 135C	635 Hours	3/231/0
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0
LU	Latch-up	(per JESD78)	3/18/0
TC	Temperature Cycle, -65/150C	500 Cycles	3/18/0

- Qual Device TPS51217DSC is qualified at LEVEL2-260C
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7 eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN ww admin team@list.ti.com

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